Patent Case No.: 58355US002

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

t Named Inventor:

THEISS, STEVEN D

Application No.:

10/734684

Group Art Unit:

1765

Filed:

December 12, 2003

Examiner:

Unknown

Title:

METHOD FOR PATTERNING FILMS

'n.

## INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on:

Dear Sir:

Pursuant to 37 CFR §§ 1.56, 1.97, and 1.98, enclosed is a completed Form PTO-1449. citing references submitted for consideration by the Examiner. Copies of any cited foreign patents, non-patent literature, and unpublished US application documents are enclosed. Pursuant to the waiver in the Pre-OG Notice, dated July 11, 2003, copies of US patents and published US patent applications are no longer required and are not enclosed. It is respectfully requested that the Examiner initial and return the enclosed Form PTO-1449 to indicate that each reference has been considered.

If a first Office Action on the merits has been mailed prior to the mailing date of this document, please charge the fee for consideration of an Information Disclosure Statement set forth in 37 CFR § 1.17(p), and if necessary, please charge any additional fees, or credit any overpayment to Deposit Account No. 13-3723.

Respectfully submitted,

Lisa P. Fulton, Reg. No.: 55,195 Telephone No.: (651) 733-1260

Office of Intellectual Property Counsel 3M Innovative Properties Company Facsimile No.: 651-736-3833

Substitute for form 1449A/PTO (modified)

## INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(Use as many sheets as necessary)

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First Named Inventor	Theiss, Steven D	
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Examiner Name		
Attorney Case Number	58355US002	

TR.	AUD AND		U.S. Patent	Documents	·		
Exam. Init.*	Cite No.	Document Number  Doc. Number-(Kind Code if Known)	Publication Date or Issue Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns Relevant Passag Figures A	es or Relevant	
	A1	US- 5,536,319	07/16/96	Wary et al.		· · · · · · · · · · · · · · · · · · ·	
	A2	US- 5,846,694	12/08/98	Strand et al.		··· <u>-</u>	
	А3	US- 6,087,270	07/11/00	Reinberg et al.	-		
	A4	US- 6,319,784 B1	11/20/01	Yu et al.			
	A5	US- 6,433,359	08/13/02	Kelley et al.			
	A6	US- 6,617,609	09/09/03	Kelley et al.			
	A7	US- 2002-0167067 A1	11/14/02	Kim			
	A8	US- 2003-0102471 A1	06/05/03	Kelley et al.			
	A9	US- 2003-0105365 A1	06/05/03	Smith et al.			
	A10	US- 2003-0100779 A1	05/29/03	Vogel et al.			
	A11	US- 2003-0150384 A1	08/14/03	Baude et al.			
	A12	US- 2003-0151118 A1	08/14/03	Baude et al.			
	A13	US- 2003-0152691 A1	08/14/03	Baude et al.			
			OTHER DO	CUMENTS	<u> </u>	<del></del>	
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	C1	S.M. Sze, Physics of Semiconductor Devices, 2 <sup>nd</sup> Ed., John Wiley and Sons, p. 492, New York (1981)					
	C2 NIST Special Publication 922 "Polycyclic Aromatic Hydrocarbon Structure Index," U.S. Govt. Printing Office, by Sander & Wise (1997)  C3 P. Reinig et al., "Crystalline Silicon Films Grown by Pulsed DC Magnetrol Sputtering", J. Non-Crystalline Solids, 299-302, pp. 128-132 (2002)						
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	Plastic Substrates," J. Vac. Sci. Technol., A, 17(4) pp. 1946-49 (1999)  C5 U.S.S.N. 10/434,377, filed May 8, 2003, "Organic Polymers, Electronic Devices, and Methods" (Bai et al.)						
	C6	U.S.S.N. 10/620,027, filed July 15, 2003, "Bis[2-acenyl]Acetylene Semiconductors" (Gerlach)					
	C7 U.S.S.N. 10/642919, filed August 18, 2003, "Method for Sealing Thin Film Transistors (Muyres et al.)						

*Examiner	•
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Date Considered:

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.